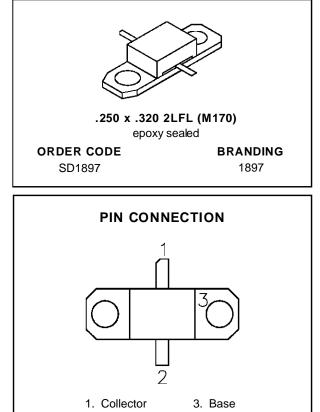


## SD1897

# RF & MICROWAVE TRANSISTORS 1.65 GHz SATCOM APPLICATIONS

- 1.65 GHz
- 28 VOLTS
- CLASS C OPERATION
- COMMON BASE
- POUT = 10 W MIN. WITH 11.0 dB GAIN



2. Emitter

#### DESCRIPTION

The SD1897 is a 28 V Class C silicon NPN transistor designed for INMARSAT and other 1.65 GHz SATCOM applications. A gold metallized emitterballasted die geometry is employed providing high gain and efficiency while ensuring long term reliability and ruggedness under severe operating conditions. SD1897 is packaged in a cost-effective epoxy sealed housing.

#### **ABSOLUTE MAXIMUM RATINGS** ( $T_{case} = 25^{\circ}C$ )

Symbol	Parameter	Value	Unit	
Vсво	Collector-Base Voltage	45	V	
V <sub>CEO</sub>	Collector-Emitter Voltage	15	V	
V <sub>EBO</sub>	Emitter-Base Voltage	3.5	V	
lc	Device Current	2.3	А	
PDISS	Power Dissipation	29	W	
TJ	Junction Temperature	+200 °C		
T <sub>STG</sub>	Storage Temperature	– 65 to +150 °C		

#### THERMAL DATA

R <sub>TH(j-c)</sub> Junction-Case Thermal Resistance	6.0	°C/W
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### SD1897

#### **ELECTRICAL SPECIFICATIONS** ( $T_{case} = 25^{\circ}C$ )

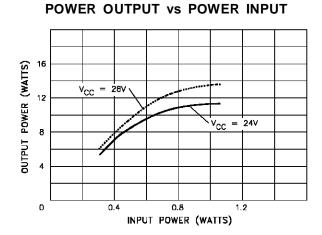
STATIC

Symbol	Test Conditions		Value			
		Min.	Тур.	Max.	Unit	
ВVсво	I <sub>C</sub> = 3mA	$I_E = 0 m A$	45	-	_	V
BVCEO	I <sub>C</sub> = 3mA	$I_B = 0mA$	12	_	_	V
BV <sub>EBO</sub>	I <sub>E</sub> = 3mA	$I_{C} = 0 mA$	3.5	-	_	V
h <sub>FE</sub>	$V_{CE} = 5V$	$I_C = 600 \text{mA}$	15	—	150	_

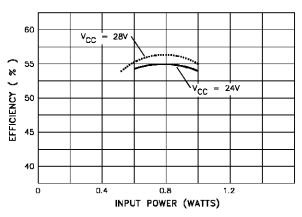
#### DYNAMIC

Symbol	Test Conditions		Value			Unit	
Symbol	Test conditions			Min.	Тур.	Max.	Omr
Роит	f = 1.65 GHz	$P_{IN} = 0.8 W$	$V_{CE} = 28 V$	10	_	_	W
GP	f = 1.65 GHz	$P_{IN} = 0.8 W$	$V_{CE} = 28 V$	11			dB
ηc	f = 1.65 GHz	$P_{IN}=0.8\ W$	$V_{CE} = 28 V$	48			%

#### TYPICAL PERFORMANCE

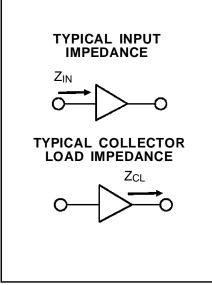


#### **EFFICIENCY vs POWER INPUT**





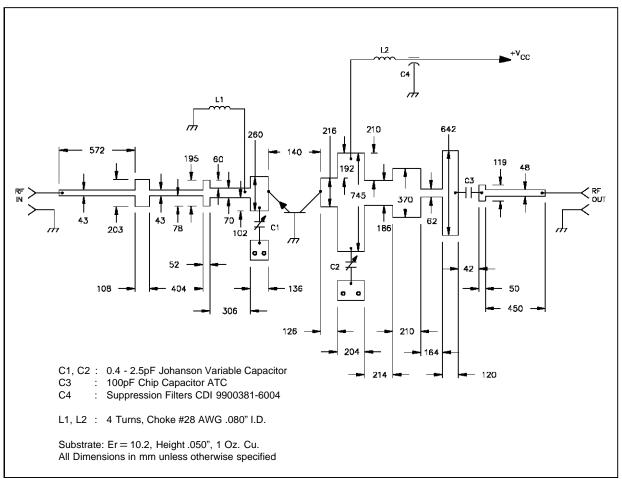
#### IMPEDANCE DATA



FREQ.	Ζιν (Ω)	Z <sub>CL</sub> (Ω)		
1600 MHz	22.0 + j 23.0	3.1 + j 4.0		
1650 MHz	28.0 + j 18.0	3.0 + j 2.0		

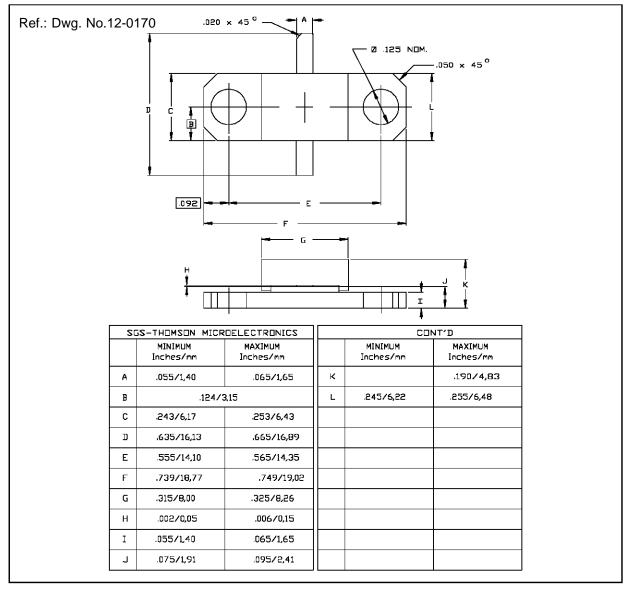
 $\begin{array}{l} P_{OUT} = 10 \ W \\ V_{CE} = 28 \ V \\ P_{IN} = 0.8 \ W \end{array} \label{eq:pour_eq}$ 

#### **TEST CIRCUIT**





#### PACKAGE MECHANICAL DATA



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